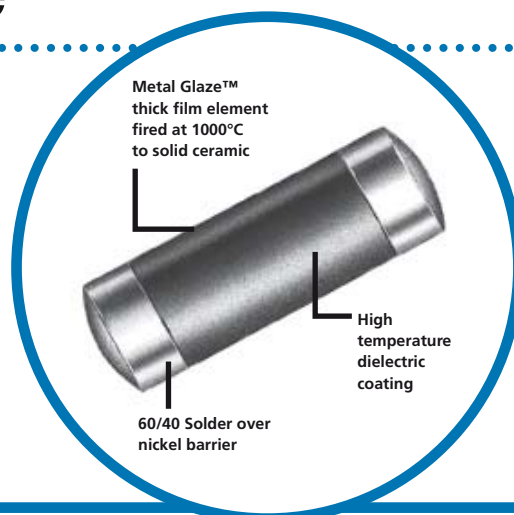


Cylindrical High Power Surface Mount Metal Glaze™

CHP Series

- Up to 2 watts
- Up to 1000 volts
- 0.2 ohm to 2.2 megohm range
- RoHS-compliant version available
- 150°C maximum operating temperature



Electrical Data

IRC Type	Industry Foot-print	Size Code ¹	Maximum Power Rating	Working Voltage ²	Maximum Voltage	Resistance Range (ohms) ³	Product Category	Tolerance (±%) ³	TCR (ppm/°C) ³
CHP 1/8	1206	B & C	1/4W @ 70°C	200	400	0.1 to 0.99	Low Range	1, 2, 5	100
						1.0 to 1.0 M	Standard	1, 2, 5	50, 100
						20 to 348K	Tight Tolerance	0.25, 0.5	50, 100
CHP 1/2	2010	D & E	1/2W @ 70°C	300	600	0.1 to 0.99	Low Range	1, 2, 5	100
						1.0 to 348K	Standard	1, 2, 5	50, 100
						20 to 348K	Tight Tolerance	0.25, 0.5	50, 100
CHP 1	2512	F	1W @ 70°C	350	700	0.1 to 0.99	Low Range	1, 2, 5	100
						1.0 to 2.21M	Standard	1, 2, 5	50, 100
						20 to 348K	Tight Tolerance	0.25, 0.5	50, 100
CHP 2	3610	H	2W @ 25°C 1.33W @ 70°C	500	1000	0.2 to 0.99	Low Range	1, 2, 5	100
						1.0 to 2.21M	Standard	1, 2, 5	50, 100

¹See page 8 for product dimensions, recommended solder pads, and standard packaging.

²Not to exceed $\sqrt{P \times R}$

³Consult factory for tighter TCR, tolerance, or resistance values.

Environmental Data

Characteristics	Maximum Change	Test Method
Temperature Coefficient	As specified	MIL-R-55342H Par 3.16 (-55°C + 125°C)
Thermal Shock	±0.5% + 0.01 ohm	MIL-R-55342H Par 3.9 (-65°C + 150°C, 5 cycles)
Low Temperature Operation	±0.25% + 0.01 ohm	MIL-R-55342H Par 3.11 (-65°C @ working voltage)
Short Time Overload	±0.5% + 0.01 ohm ±1% for R>100K ohm	MIL-R-55342H Par 3.12 2.5 x $\sqrt{P \times R}$ for 5 seconds
High Temperature Exposure	±0.5% + 0.01 ohm	MIL-R-55342H Par 3.13 (-150°C for 100 hours)
Resistance to Bonding	±0.25% + 0.01 ohm	MIL-R-55342H Par 3.14.2 (Reflow soldered to board at 260°C for 10 seconds)
Exposure	95% minimum coverage	MIL-STD-202, Method 208 (245°C for 5 seconds)
Solderability	±0.5% + 0.01 ohm	MIL-R-55342H Par 3.18 (10 cycles, total 240 hours)
Moisture Resistance	±0.5% + 0.01 ohm	MIL-R-55342H Par 3.15 (2000 hours at 70°C intermittent)
Life Test Terminal Adhesion Strength	±1% + 0.01 ohm no mechanical damage	1200 gram push from underside of mounted chip for 60 seconds
	±1% + 0.01 ohm no mechanical damage	Chip mounted in center of 90mm long board, deflected 1mm so as to exert pull on chip contacts for 5 seconds

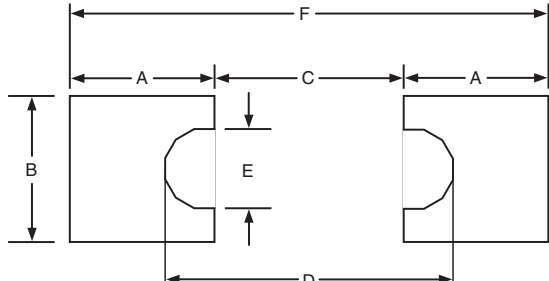
General Note

TT electronics reserves the right to make changes in product specification without notice or liability.
All information is subject to TT electronics' own data and is considered accurate at time of going to print.

Physical Data

IRC Type	Size Code	Industry Footprint	Actual Size			
				Dimensions (Inches and (mm))		
				L	W	C
CHP 1/8	B	1206		0.128 ± 0.007 (3.25 ± 0.18)	0.057 ± 0.006 (1.45 ± 0.15)	0.020 ± 0.010 (0.51 ± 0.25)
MRC 1/2	C	1206		0.128 ± 0.007 (3.25 ± 0.18)	0.063 ± 0.010 (1.60 ± 0.25)	0.020 ± 0.010 (0.51 ± 0.25)
CHP 1/2	D	2010		0.200 ± 0.010 (5.08 ± 0.25)	0.079 (nom.) -0.006 / +0.011 (2.01 (nom.) -0.15 / +0.28)	0.030 ± 0.010 (0.761 ± 0.25)
CHP 1	F	2512		0.251 ± 0.010 (6.38 ± 0.25)	0.079 (nom.) -0.006 / +0.011 (2.01 (nom.) -0.15 / +0.28)	0.040 ± 0.010 (1.02 ± 0.25)
CHP 2	H	3610		0.367 ± 0.010 (9.32 ± 0.25)	0.105 (nom.) -0.006 / +0.011 (2.67 (nom.) -0.15 / +0.28)	0.050 ± 0.010 (1.27 ± 0.25)

Recommended Solder Pad Dimensions (Reflow):

							
Size Code	Industry Footprint	Dimensions (Inches and (mm))					
		A	B	C	D	E	F
B & C	1206	0.076 (1.93)	0.093 (2.36)	0.058 (1.47)	0.098 (2.49)	0.032 (0.81)	0.211 (5.36)
D	2010	0.111 (2.82)	0.126 (3.20)	0.096 (2.44)	0.152 (3.86)	0.040 (1.02)	0.318 (8.08)
E	2010	0.170 (4.32)	0.160 (4.06)	0.072 (1.83)	0.132 (3.35)	0.044 (1.12)	0.412 (10.46)
F	2512	0.121 (3.07)	0.126 (3.20)	0.127 (3.23)	0.183 (4.65)	0.040 (1.02)	0.369 (9.37)
H	3610	0.170 (4.32)	0.160 (4.06)	0.213 (5.41)	0.273 (6.93)	0.044 (1.12)	0.553 (14.05)

General Note

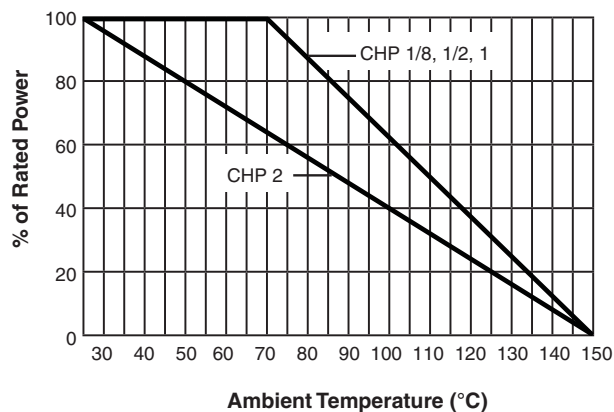
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Standard Reel Packaging per EIA-481:

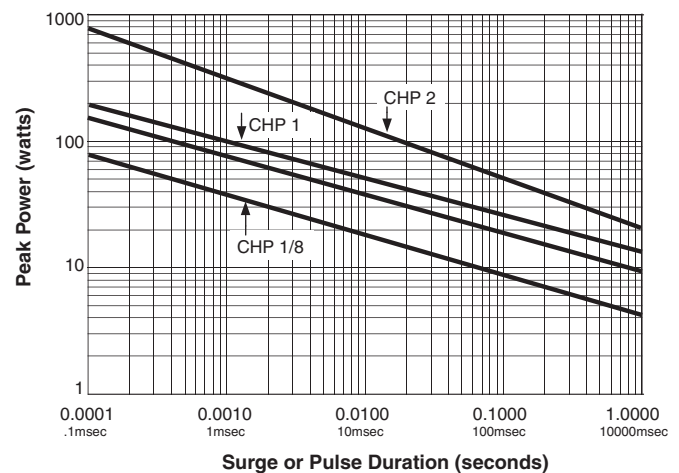
IRC Type	Size Code	Industry Footprint	Reel Diameter*	Quantity Per Reel	Carrier Tape Width	Component Pitch
CHP 1/8 MRC 1/2	B C	1206	7"	2,500 max.	8mm	4mm
			13"	10,000 max.		
CHP 1/2 MRC 1	D E	2010	7"	1,500 max.	12mm	4mm
			13"	5,000 max.		
CHP 1	F	2512	7"	1,500 max.	12mm	4mm
			13"	5,000 max.		
CHP 2	H	3610	13"	1,500 max.	24mm	4mm

*The 13" reel is considered standard and will be supplied unless otherwise specified.

Power Derating Curve



Repetitive Surge Curve



Note: Use for repetitive pulses where the average power dissipation is not to exceed the component rating at 70°C. Surge handling capacity for low-repetitive surges may be significantly greater than shown above. Contact factory for recommendations.

Ordering Data

Sample Part No. **CHP 1** - **100** **2203** **F** **13** **LF**

IRC Type
(CHP 1/8, CHP 1/2, CHP 1, or CHP 2)

Temperature Coefficient
(50 ppm, 100 ppm)

Resistance Value
(100 ohms and greater - First 3 significant digits plus 4th digit multiplier)
Example: 100 ohms = 1000, 1000 ohms = 1001, 150,000 ohms = 1503
(Less than 100 ohms - "R" is used to designate decimal)
Example: 51 ohms = 51R0, 1 ohm = 1R00, 0.25 ohms = R250

Tolerance
(C = 0.25%, D = 0.5%, F = 1.0%; G = 2.0%; J = 5.0%)

Packaging Code*
(BLK = Bulk, 7 = 7" Reel, 13 = 13" Reel)

Lead Free Construction

General Note

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